2MBI1400XXB120P-50

IGBT Modules

Power Module (X series)
1200V / 1400A / 2-in-1 package

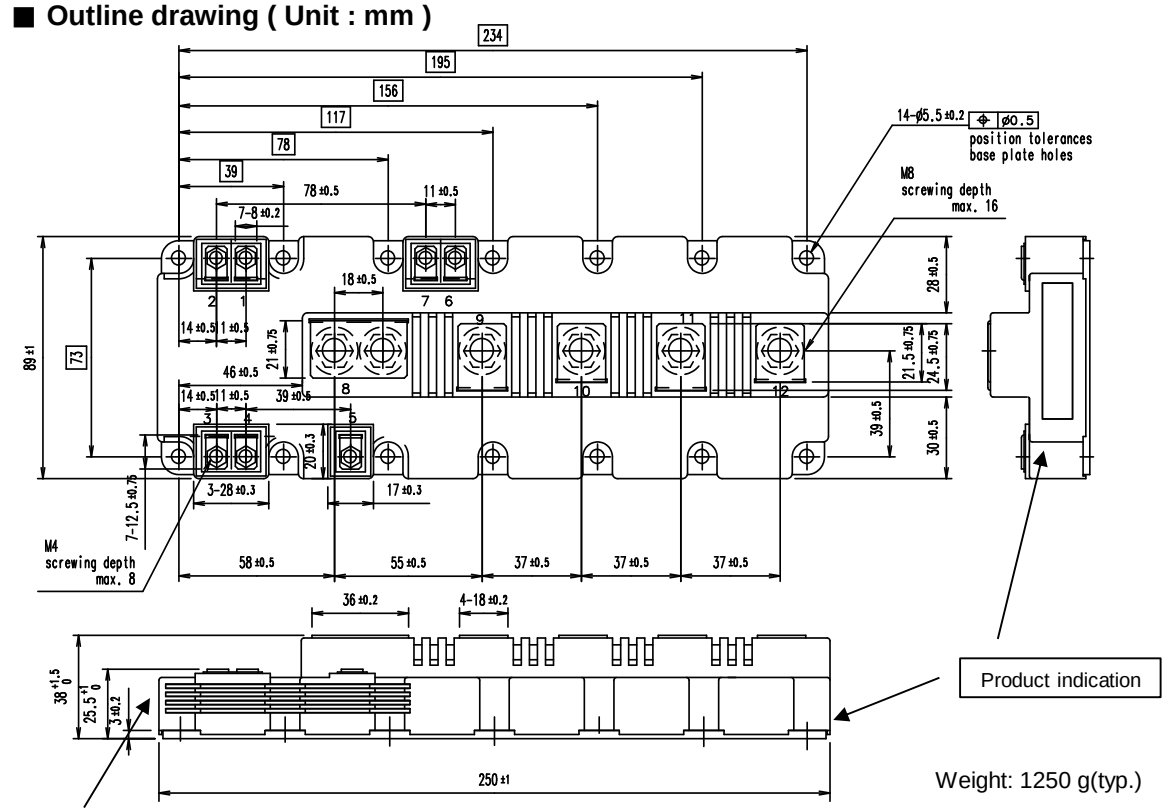
■ Features

Low $V_{CE(sat)}$
Low Inductance Module structure

■ Applications

Inverter for Motor Drives, AC and DC Servo Drives
Uninterruptible Power Supply Systems, Wind Turbines, PV Power Conditioning Systems

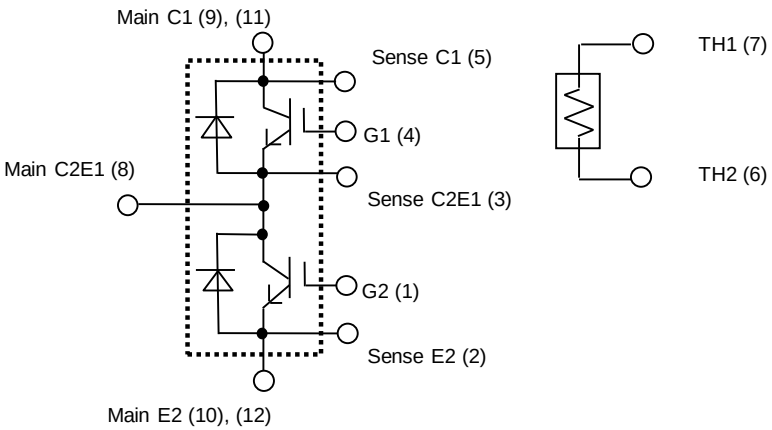
■ Outline drawing (Unit : mm)



Weight: 1250 g(typ.)

■ Equivalent Circuit

[Inverter] [Thermistor]



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■ Absolute Maximum Ratings (at T_C= 25°C unless otherwise specified)

Items		Symbols	Conditions		Maximum Ratings	Units
Inverter	Collector-Emitter voltage, Gate-Emitter short-circuited	V_{CES}			1200	V
	Gate-Emitter voltage, Collector-Emitter short-circuited	V_{GES}			±20	V
	Collector current	I_C	Continuous	T_C=90°C	1400	A
	Repetitive peak collector current	I_{CRM}	1ms		2800	
	Forward current	I_F			1400	
	Repetitive peak forward current	I_{FRM}	1ms		2800	
	Total power dissipation	P_{tot}	1 device		5.4	kW
	Virtual junction temperature	T_{vj}			175	°C
	Operating virtual junction temperature (under switching conditions)	T_{vjop}			175	
Case temperature		T_c			150	
Storage temperature		T_{stg}			-40 ~ 150	
Isolation voltage	between terminal and copper base (*1)	V_{isol}	AC: 1min.		4000	Vrms
	between thermistor and others (*2)					
Mounting torque of screws to heatsink (*3)		M_s	M5		6.0	N·m
Mounting torque of screws to main terminals (*3)		M_t	M8		10.0	
Mounting torque of screws to sense terminals (*3)			M4		2.1	

(*1) All terminals should be connected together during the test.

(*2) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

(*3) Recommendable Value: : Mounting torque of screws to heatsink 3.0 ~ 6.0 N·m (M5)
: Mounting torque of screws to main terminals 8.0~ 10.0 N·m (M8)
: Mounting torque of screws to sense terminals 1.8~ 2.1 N·m (M4)

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■ Electrical characteristics (at T_{vj}= 25°C unless otherwise specified)

	Items	Symbols	Conditions		Characteristics min.	Characteristics typ.	Characteristics max.	Units
Inverter	Collector-Emitter cut-off current, Gate-Emitter short-circuited	I_{CES}	V_{GE} = 0V V_{CE} = 1200V		-	-	600	μA
	Gate leakage current, Collector-Emitter short-circuited	I_{GES}	V_{CE}=0V, V_{GE}=±20V		-	-	1200	nA
	Gate-Emitter threshold voltage	$V_{GE(th)}$	V_{CE} = 20V I_C = 1400mA		6.0	6.5	7.0	V
	Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	V_{GE} = 15V I_C= 1400A	T_{vj}=25°C	-	1.50	1.95	V
		$V_{CE(sat)}$ (chip)		T_{vj}=25°C	-	1.45	1.90	
				T_{vj}=125°C	-	1.70	-	
				T_{vj}=150°C	-	1.80	-	
				T_{vj}=175°C	-	1.85	-	
	Internal gate resistance	r_g	-		-	2.50	-	Ω
	Capacitance	C_{ies}	V_{CE}=10V, V_{GE}=0V, f=1MHz		-	147	-	nF
		C_{oes}			-	5.0	-	
		C_{res}			-	1.3	-	
	Gate charge	Q_G	V_{CC} = 600V, I_C = 1400A V_{GE} = -15 → +15V		-	9.5	-	μC
	Forward voltage	V_F (terminal)	V_{GE} = 0V I_F= 1400A	T_{vj}=25°C	-	1.70	2.15	V
		V_F (chip)		T_{vj}= 25°C	-	1.65	2.10	
				T_{vj}=125°C	-	1.70	-	
				T_{vj}=150°C	-	1.65	-	
				T_{vj}=175°C	-	1.65	-	
	Switching time (*1)	$t_{d(on)}$	V_{CC} = 600V I_C, I_F = 1400A V_{GE} = ±15 V R_G = ±0.68 Ω L_S = 40 nH	T_{vj}= 25°C	-	1.10	-	μs
				T_{vj}=125°C	-	1.10	-	
				T_{vj}=150°C	-	1.10	-	
				T_{vj}=175°C	-	1.10	-	
		t_r		T_{vj}= 25°C	-	0.20	-	
				T_{vj}=125°C	-	0.22	-	
				T_{vj}=150°C	-	0.22	-	
				T_{vj}=175°C	-	0.22	-	
		$t_{d(off)}$		T_{vj}= 25°C	-	0.90	-	
				T_{vj}=125°C	-	0.94	-	
				T_{vj}=150°C	-	0.96	-	
				T_{vj}=175°C	-	0.97	-	
		t_f		T_{vj}= 25°C	-	0.16	-	
				T_{vj}=125°C	-	0.17	-	
				T_{vj}=150°C	-	0.18	-	
				T_{vj}=175°C	-	0.20	-	
	Reverse recovery time	t_{rr}		T_{vj}= 25°C	-	0.29	-	
				T_{vj}=125°C	-	0.47	-	
				T_{vj}=150°C	-	0.49	-	
				T_{vj}=175°C	-	0.52	-	

(*1) Turn on time (t_{on}) = $t_{d(on)}$+ t_r , Turn off time (t_{off}) = $t_{d(off)}$ + t_f

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■ Electrical characteristics (at T_{vj}= 25°C unless otherwise specified)

Items		Symbols	Conditions		Characteristics min.	Characteristics typ.	Characteristics max.	Units
Inverter	Switching loss (per pulse)	E_{on}	V_{CC} = 600V, I_C, I_F = 1400A, V_{GE} = ±15 V, R_G = ±0.68 Ω, L_S = 40 nH	T_{vj}= 25°C	-	128	-	mJ
				T_{vj}=125°C	-	193	-	
				T_{vj}=150°C	-	201	-	
				T_{vj}=175°C	-	216	-	
		E_{off}		T_{vj}= 25°C	-	191	-	
				T_{vj}=125°C	-	243	-	
				T_{vj}=150°C	-	257	-	
				T_{vj}=175°C	-	265	-	
		E_{rr}		T_{vj}= 25°C	-	55	-	
				T_{vj}=125°C	-	87	-	
				T_{vj}=150°C	-	103	-	
				T_{vj}=175°C	-	114	-	
Thermistor	Resistance	R	T = 25°C		-	5000	-	Ω
			T = 100°C		465	495	520	
	B value	B	T = 25/ 50°C		3305	3375	3450	K

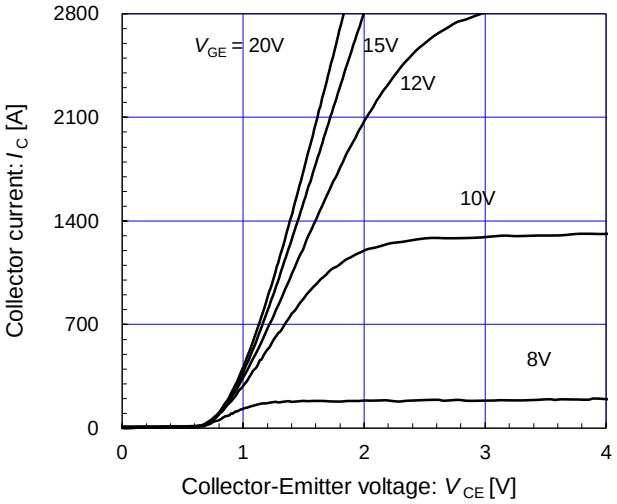
NOTICE:
The external gate resistance (R_G) shown above is one of our recommended value for the purpose of minimum switching loss. However the optimum R_G depends on circuit configuration and/or environment. We recommend that the R_G has to be carefully chosen based on consideration if IGBT module matches design criteria, for example, switching loss, EMC/EMI, spike voltage, surge current and no unexpected oscillation and so on.

■Thermal resistance characteristics

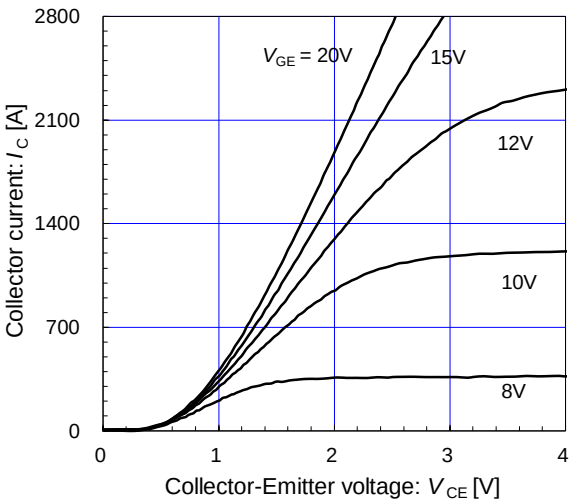
Items	Symbols	Conditions	Characteristics min.	Characteristics typ.	Characteristics max.	Units
Thermal resistance junction to case(1 device)	$R_{th(j-c)}$	Inverter IGBT	-	-	27.5	K/kW
		Inverter FWD	-	-	48.0	
Thermal resistance case to heatsink(1 IGBT+1 FWD) (*1)	$R_{th(c-s)}$	with 1 W/(m·K) thermal grease	-	4.2	-	

(*1) This is the value which is defined mounting on the additional heatsink with thermal grease.

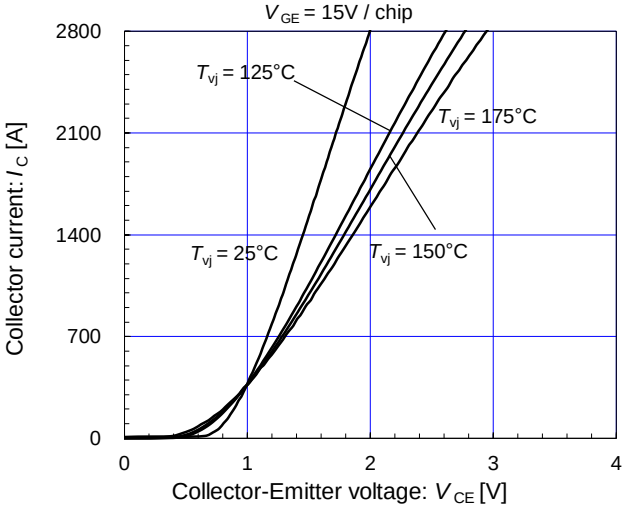
[Inverter]
Collector current vs. Collector-Emitter voltage
T_{vj} = 25°C / chip



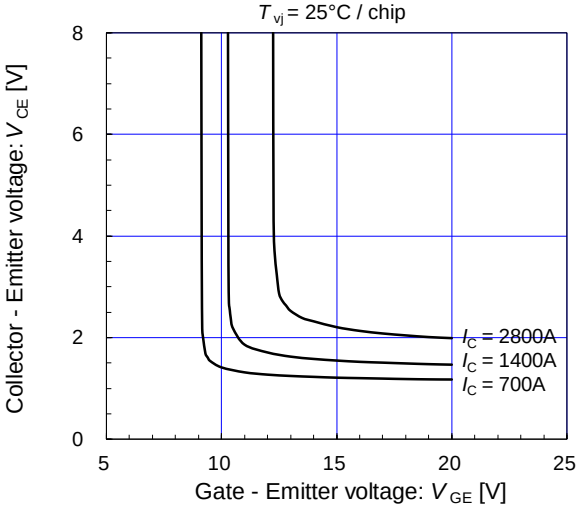
[Inverter]
Collector current vs. Collector-Emitter
T_{vj} = 175°C / chip



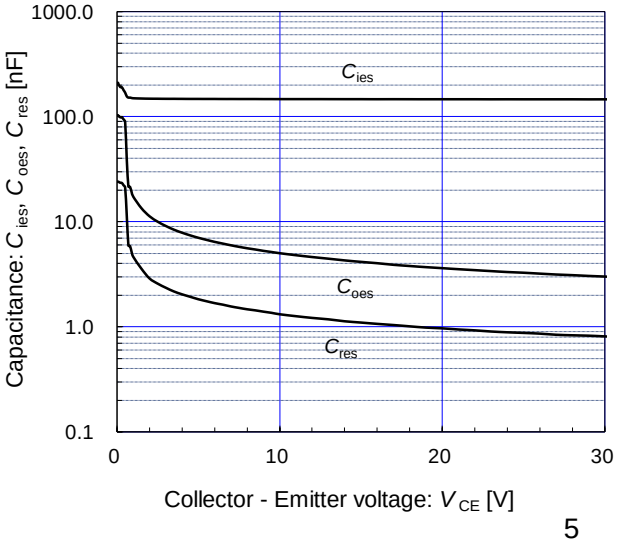
[Inverter]
Collector current vs. Collector-Emitter voltage
V_{GE} = 15V / chip



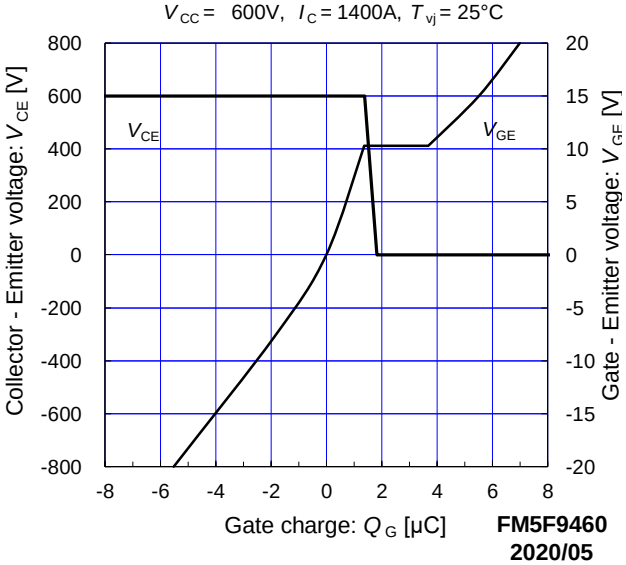
[Inverter]
Collector-Emitter voltage vs. Gate-Emitter voltage
T_{vj} = 25°C / chip



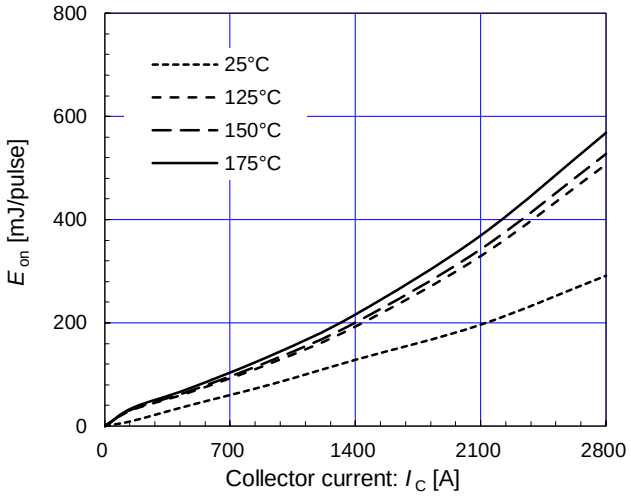
[Inverter]
Capacitance vs. Collector-Emitter Voltage (typ.)
V_{GE} = 0V, f = 1MHz, T_{vj} = 25°C



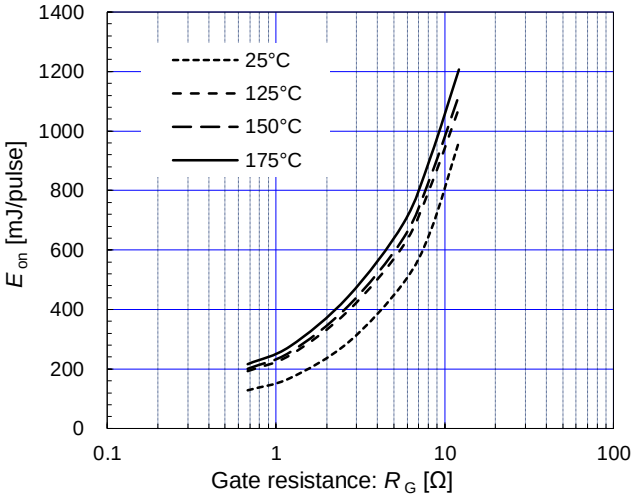
[Inverter]
Dynamic Gate Charge (typ.)
V_{CC} = 600V, I_C = 1400A, T_{vj} = 25°C



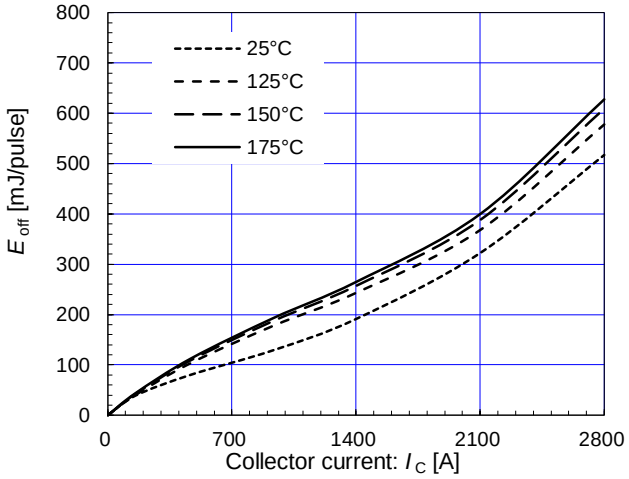
[Inverter]
E_{on} vs. Collector current (typ.)
V_{CC} = 600V, V_{GE} = ±15 V, R_G = ±0.68 Ω



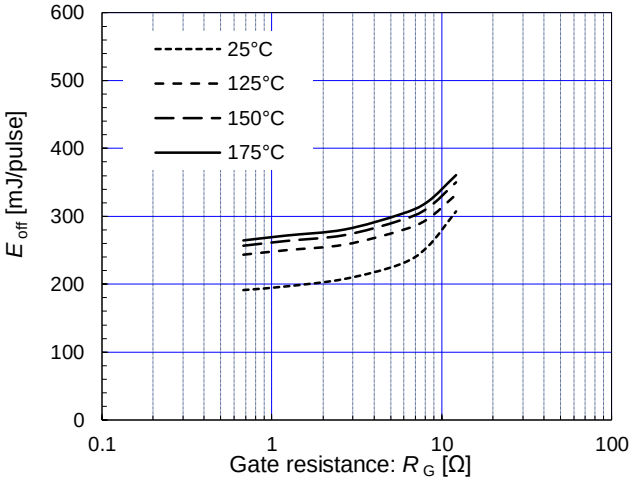
[Inverter]
E_{on} vs. Gate resistance (typ.)
V_{CC} = 600V, V_{GE} = ±15 V, I_C = 1400A



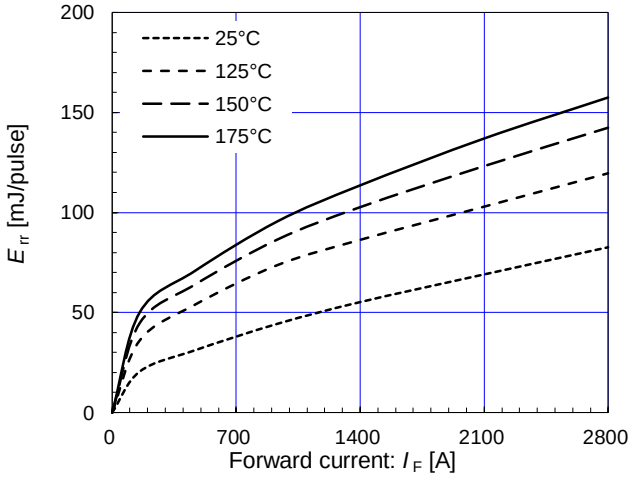
[Inverter]
E_{off} vs. Collector current (typ.)
V_{CC} = 600V, V_{GE} = ±15 V, R_G = ±0.68 Ω



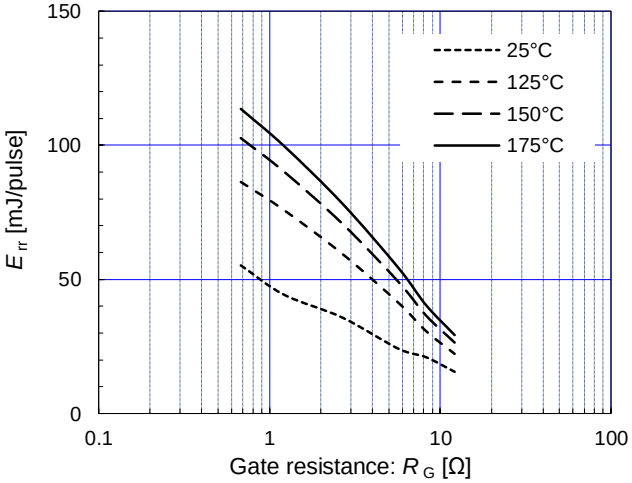
[Inverter]
E_{off} vs. Gate resistance (typ.)
V_{CC} = 600V, V_{GE} = ±15 V, I_C = 1400A



[Inverter]
E_{rr} vs. Forward current (typ.)
V_{CC} = 600V, V_{GE} = ±15 V, R_G = ±0.68 Ω



[Inverter]
E_{rr} vs. Gate resistance (typ.)
V_{CC} = 600V, V_{GE} = ±15 V, I_F = 1400A



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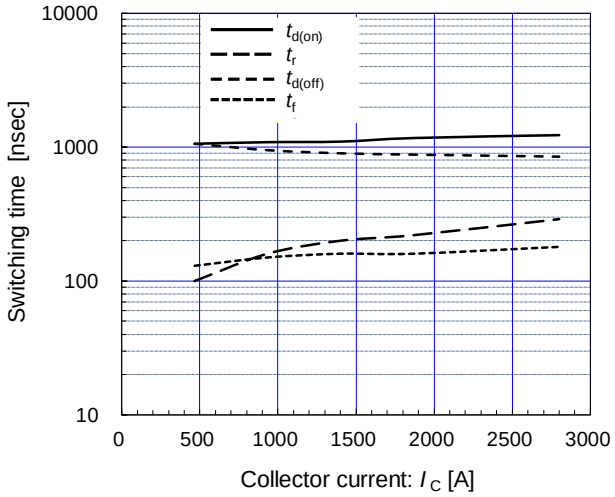
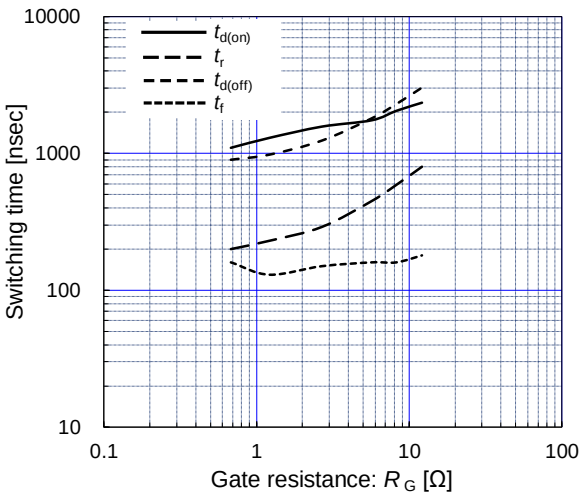
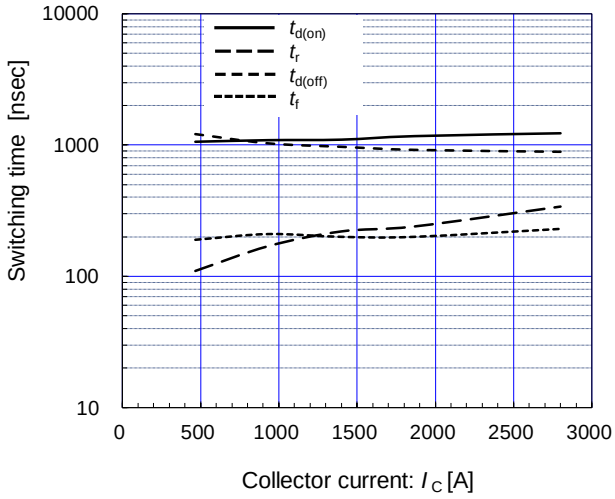
[Inverter]
Switching time vs. Collector current (typ.)
V_{CC} = 600V, R_G = ±0.68 Ω, V_{GE} = ±15 V, T_{vj} = 25°C



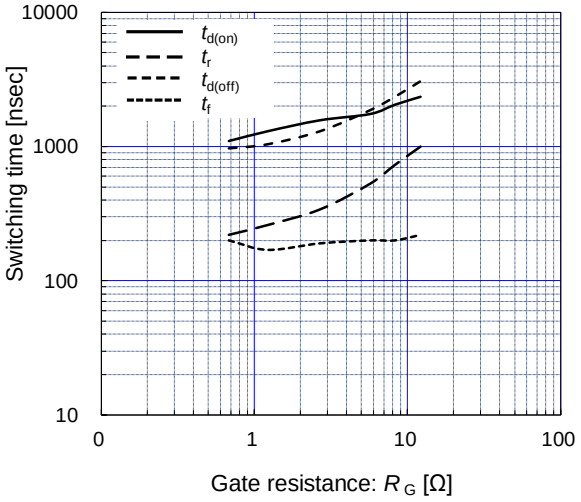
[Inverter]
Switching time vs. Gate resistance (typ.)
V_{CC} = 600V, I_C = 1400A, V_{GE} = ±15 V T_{vj} = 25°C



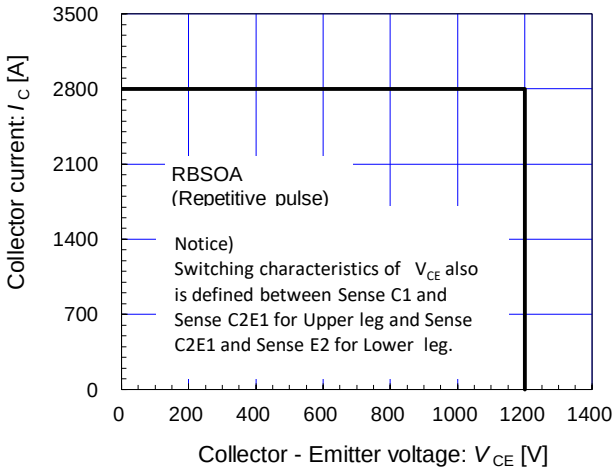
[Inverter]
Switching time vs. Collector current (typ.)
V_{CC} = 600V, R_G = ±0.68 Ω, V_{GE} = ±15 V, T_{vj} = 175°C



[Inverter]
Switching time vs. Gate resistance (typ.)
V_{CC} = 600V, I_C = 1400A, V_{GE} = ±15 V T_{vj} = 175°C



[Inverter]
Reverse bias safe operating area (max.)
V_{GE} = ±15 V, R_G = ±0.68 Ω, T_{vj} = 175°C



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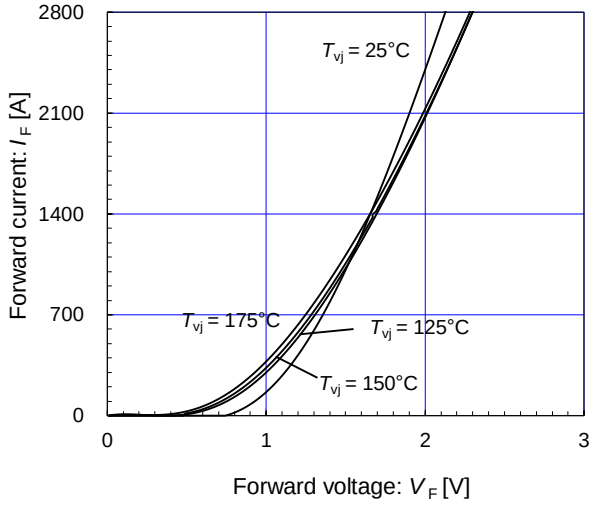
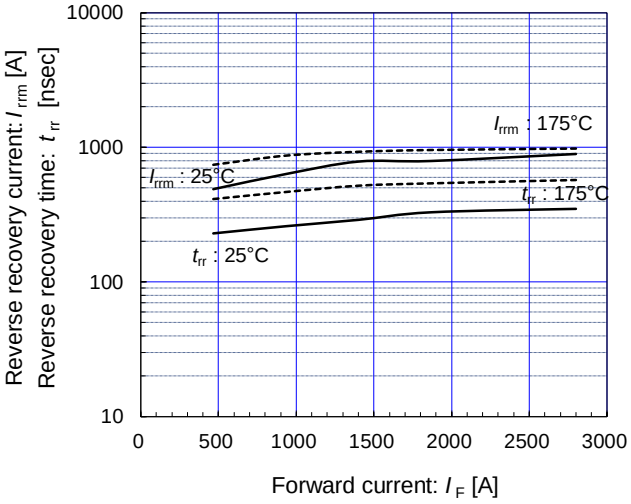
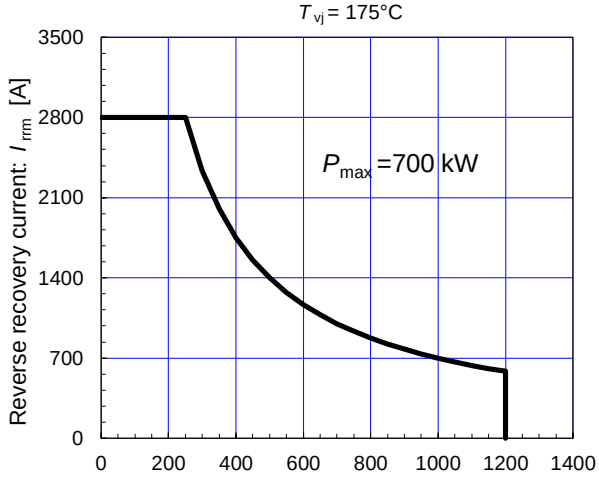
[Inverter]
Forward current vs. Forward voltage (typ.)
chip



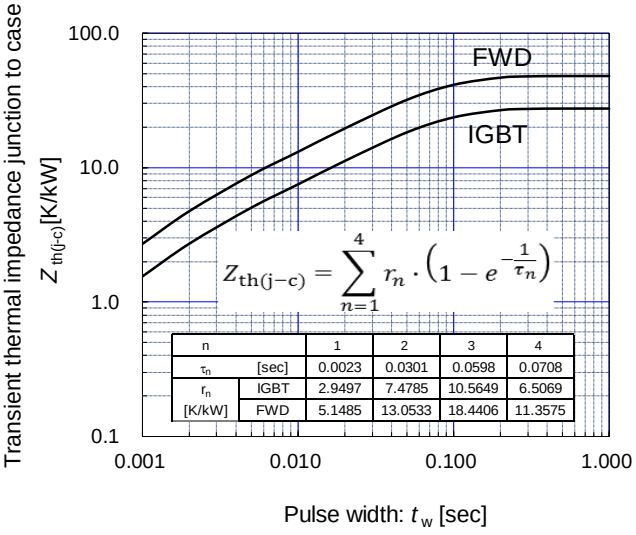
[Inverter]
Reverse recovery characteristics (typ.)
V_{CC} = 600V, V_{GE} = ±15 V, R_G = ±0.68 Ω



[Inverter]
FWD safe operation area (max.)
T_{vj} = 175°C

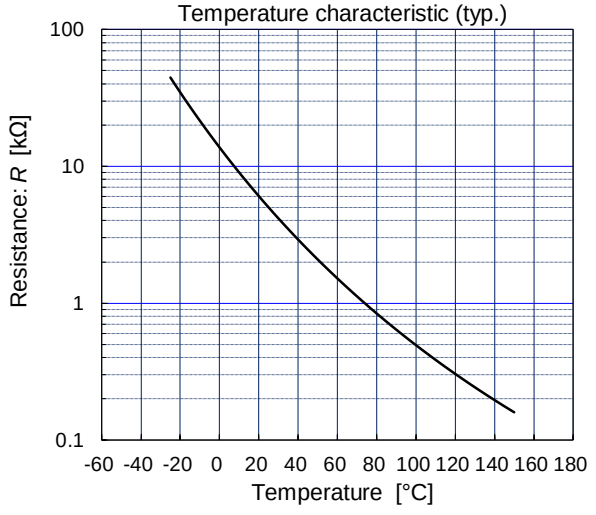


[Inverter]
Transient Thermal impedance (max.)



n		1	2	3	4
τ_n	[sec]	0.0023	0.0301	0.0598	0.0708
r_n	IGBT	2.9497	7.4785	10.5649	6.5069
[K/kW]	FWD	5.1485	13.0533	18.4406	11.3575

[Thermistor]
Temperature characteristic (typ.)



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Warnings

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・Machine tools ・Audiovisual equipment ・Electrical home appliances ・Personal equipment ・Industrial robots etc.

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・Traffic-signal control equipment ・Gas leakage detectors with an auto-shut-off feature
・Emergency equipment for responding to disasters and anti-burglary devices ・Safety devices ・Medical equipment

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富士電機 Innovating Energy Technology

Technical Information

IGBT Modules

- Please refer to URLs below for futher information about products, application manuals and design support.
- 关于本规格书中没有记载的产品信息，应用手册，技术信息等，请参考以下链接。
- 本データシートに記載されていない製品情報，アプリケーションマニュアル，デザインサポートは以下のURLをご参照下さい。

FUJI ELECTRIC Power Semiconductor WEB site

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4 Design Support	www.fujielectric.com/products/semiconductor/model/igbt/technical/
5 Mounting Instructions	www.fujielectric.com/products/semiconductor/model/igbt/mounting/
6 IGBT Loss Simulation Software	www.fujielectric.com/products/semiconductor/model/igbt/simulation/
7 Fuji Electric Journal	www.fujielectric.com/products/semiconductor/journal/
8 Contact	www.fujielectric.com/contact/
9 Revised and discontinued product information	www.fujielectric.com/products/semiconductor/discontinued/

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